MSC030SDA330B

Zero Recovery Silicon Carbide Schottky Diode

Product Overview

The silicon carbide (SiC) power Schottky barrier diode (SBD) product line from Microchip increases the performance over silicon diode solutions while lowering the total cost of ownership for high-voltage applications. The MSC030SDA330B device is a 3300 V, 30 A SiC SBD in a two-lead TO-247 package.



Features

The following are key features of the MSC030SDA330B device:

- · No reverse recovery
- · Low forward voltage
- Low leakage current
- RoHS compliant

Benefits

The following are benefits of the MSC030SDA330B device:

- · High switching frequency
- · Low switching losses
- · Low noise (EMI) switching
- · Higher reliability systems
- · Increased system power density

Applications

The MSC030SDA330B device is designed for the following applications:

- Power factor correction (PFC)
- · Anti-parallel diode
 - Switch-mode power supply
 - Inverters/converters
 - Motor controllers
- · Freewheeling diode
 - Switch-mode power supply
 - Inverters/converters
- Snubber/clamp diode

1. Device Specifications

This section shows the specifications of the MSC030SDA330B device.

1.1 Absolute Maximum Ratings

The following table shows the absolute maximum ratings of the MSC030SDA330B device. T_C = 25 °C unless otherwise specified.

Table 1-1. Absolute Maximum Ratings

Symbol	Parameter			Unit
V_R	Maximum DC reverse voltage			V
V_{RRM}	Maximum peak repetitive reverse voltage			
V_{RWM}	Maximum working peak reverse voltage			
I _F	$T_{\rm F}$ Maximum DC forward current $T_{\rm C} = T_{\rm C}$		62	Α
			30	
		T _C = 145 °C	25	
I _{FRM}	Repetitive peak forward surge current (T_C = 25 °C, tp = 8.3 ms, half sine wave)			
I _{FSM}	Non-repetitive forward surge current (T_C = 25 °C, tp = 8.3 ms, half sine wave)		205	
P _{TOT} Total power dissipation	Total power dissipation	T _C = 25 °C	556	W
		T _C = 110 °C	241	

The following table shows the thermal and mechanical characteristics of the MSC030SDA330B device.

Table 1-2. Thermal and Mechanical Characteristics

Symbol	Characteristic/Test Conditions	Min	Тур	Max	Unit
$R_{\theta JC}$	Junction-to-case thermal resistance		0.19	0.27	°C/W
T _J , T _{STG}	Operating junction and storage temperature range	- 55		175	°C
T _L	Lead temperature for 10 seconds			300	
Wt	Package weight		0.22		oz
			6.2		g
	Mounting torque, 6-32 or M3 screw			10	lbf-in
				1.1	N-m

1.2 Electrical Performance

The following table shows the static characteristics of the MSC030SDA330B device. T_J = 25 °C unless otherwise specified.

Table 1-3. Static Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
V _F	Forward voltage	I _F = 30 A, T _J = 25 °C		2.1	2.4	V
		I _F = 30 A, T _J = 175 °C		4.6		
I _{RM}	Reverse leakage current	V _R = 3300 V, T _J = 25 °C		5	200	μA
		V _R = 3300 V, T _J = 175 °C		50		
Q _C	Total capacitive charge	V _R = 1650 V		274		nC
CJ	Junction capacitance	V _R = 1 V, f = 1 MHz		1850		pF
		V _R = 1100 V, f = 1 MHz		107		
		V _R = 2200 V, f = 1 MHz		78		

1.3 Typical Performance Curves

This section shows the typical performance curves of the MSC030SDA330B device.

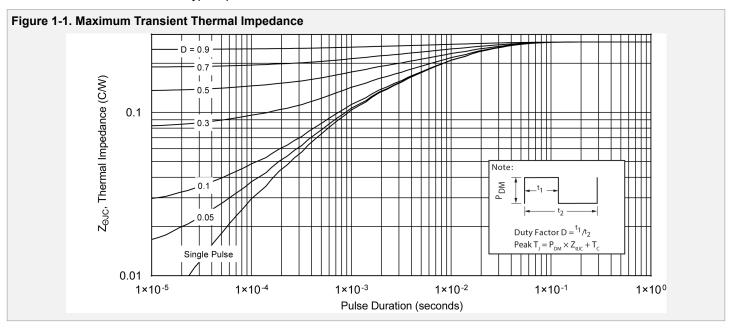


Figure 1-2. Forward Current vs. Forward Voltage

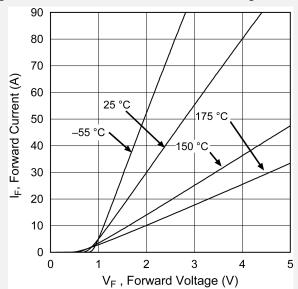


Figure 1-3. Max. Forward Current vs. Case Temp.

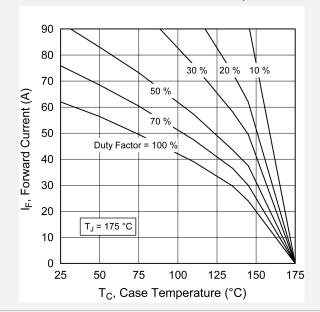


Figure 1-4. Max. Power Dissipation vs. Case Temp.

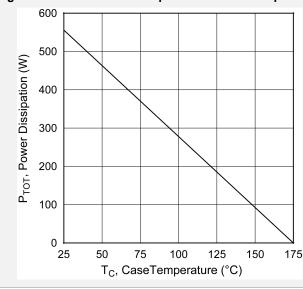
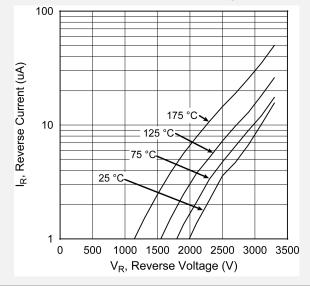


Figure 1-5. Reverse Current vs. Reverse Voltage



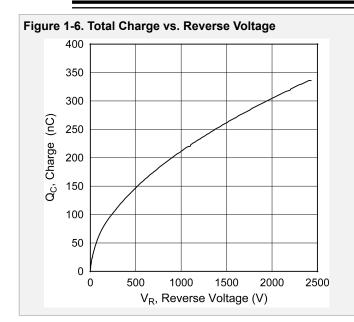


Figure 1-7. Capacitance vs. Reverse Voltage

2500

(b)
2000

1500

1000

0.1

1 10 100 1000 10000

V_R, Reverse Voltage (V)

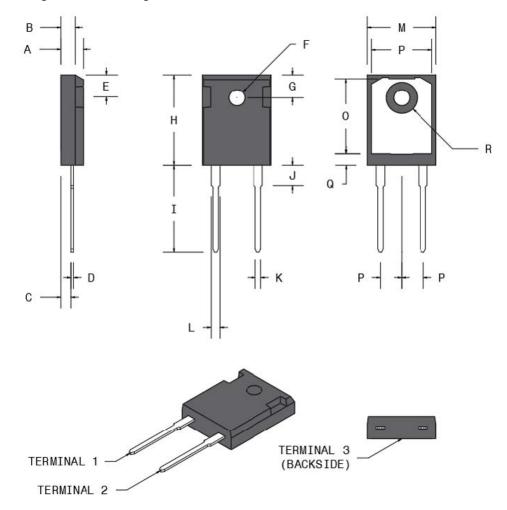
2. Package Specification

This section shows the package specification of the MSC030SDA330B device.

2.1 Package Outline Drawing

The following figure illustrates the TO-247 package outline of the MSC030SDA330B device.

Figure 2-1. Package Outline Drawing



The following table shows the TO-247 dimensions and should be used in conjunction with the package outline drawing.

Table 2-1. TO-247 Dimensions

Symbol	Min (mm)	Max (mm)	Min (in.)	Max (in.)
Α	4.69	5.31	0.185	0.209
В	1.49	2.49	0.059	0.098
С	2.21	2.59	0.087	0.102
D	0.40	0.79	0.016	0.031

MSC030SDA330B

Package Specification

continued						
Symbol	Min (mm)	Max (mm)	Min (in.)	Max (in.)		
E	5.38	6.20	0.212	0.244		
F	3.50	3.81	0.138	0.150		
G	6.15 BSC		0.242 BSC	0.242 BSC		
Н	20.80	21.46	0.819	0.845		
I	19.81	20.32	0.780	0.800		
J	4.00	4.50	0.157	0.177		
K	1.01	1.40	0.040	0.055		
L	1.65	2.13	0.065	0.084		
М	15.49	16.26	0.610	0.640		
N	13.50	14.50	0.531	0.571		
0	16.50	17.50	0.650	0.689		
Р	5.45 BSC	5.45 BSC 0.215 BSC				
Q	2.00	2.75	0.079	0.108		
R	7.10	7.50	0.280	0.295		
Terminal 1	Cathode	Cathode				
Terminal 2	Anode	Anode				
Terminal 3	Cathode					

3. Revision History

Table 3-1. Revision History

Revision	Date	Description
Α	11/2021	Document created.

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